



## SFG60N12FF\_Datasheet



# Enhancement Mode N-Channel Power MOSFET

## Features

- ◆ Low  $R_{DS(on)}$  & FOM
- ◆ Extremely low switching loss
- ◆ Excellent stability and uniformity
- ◆ Fast switching and soft recovery

## Applications

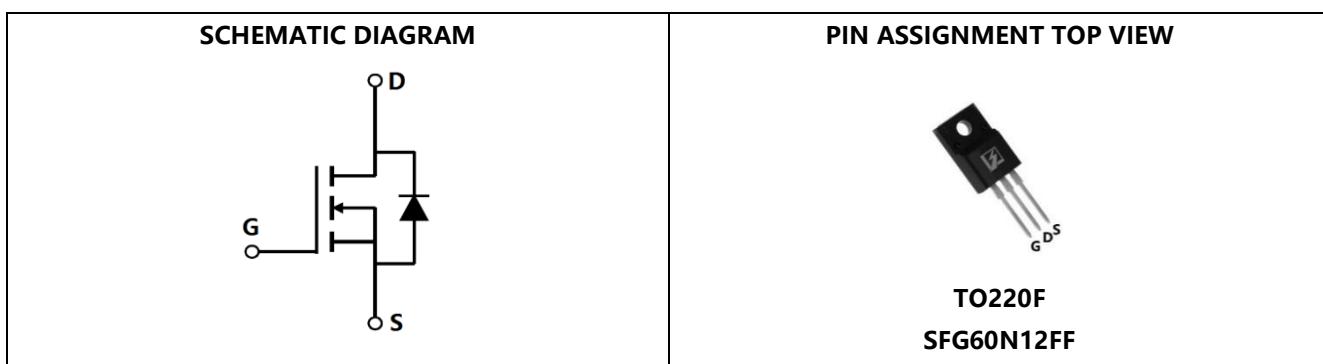
- ◆ Consumer electronic power supply
- ◆ Motor control
- ◆ Synchronous-rectification
- ◆ Isolated DC/DC convertor
- ◆ Invertors

## ■ General Description

SFG60N12FF uses advanced SFGMOS™ technology to provide low  $R_{DS(ON)}$ , low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable to use in motor control applications.

◆ $V_{DS, min}$	120 V
◆ $I_D, pulse$	180 A
◆ $R_{DS(ON)}, \text{max @ } VGS=10 \text{ V}$	13 mΩ
◆ $Q_g$	39.6 nC

## ■ Schematic and Package Information



## ■ Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	120	V
Gate source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current <sup>1)</sup> , $T_c=25^\circ\text{C}$	$I_D$	60	A
Pulsed drain current <sup>2)</sup> , $T_c=25^\circ\text{C}$	$I_{D, \text{pulse}}$	180	A
Power dissipation <sup>3)</sup> , $T_c=25^\circ\text{C}$	$P_D$	33	W
Single pulsed avalanche energy <sup>5)</sup>	$E_{AS}$	100	mJ
Operation and storage temperature	$T_{stg}, T_j$	-55 to 150	°C

## ■ Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	3.8	°C/W
Thermal resistance, junction-ambient <sup>4)</sup>	$R_{\theta JA}$	62.5	°C/W

## ■ Electrical Characteristics at $T_j=25$ °C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	$BV_{DSS}$	120			V	$V_{GS}=0$ V, $I_D=250$ μA
Gate threshold voltage	$V_{GS(th)}$	1.5		2.5	V	$V_{DS}=V_{GS}$ , $I_D=250$ μA
Drain-source on-state resistance	$R_{DS(ON)}$		10.6	13	mΩ	$V_{GS}=10$ V, $I_D=30$ A
Gate-source leakage current	$I_{GSS}$			100	nA	$V_{GS}=20$ V
				-100		$V_{GS}=-20$ V
Drain-source leakage current	$I_{DSS}$			1	μA	$V_{DS}=120$ V, $V_{GS}=0$ V

## ■ Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		2809.7		pF	$V_{GS}=0$ V, $V_{DS}=50$ V, $f=100$ kHz
Output capacitance	$C_{oss}$		356.1		pF	
Reverse transfer capacitance	$C_{rss}$		8.3		pF	
Turn-on delay time	$t_{d(on)}$		20.4		ns	$V_{GS}=10$ V, $V_{DS}=50$ V, $R_G=2$ Ω, $I_D=25$ A
Rise time	$t_r$		5.7		ns	
Turn-off delay time	$t_{d(off)}$		45.1		ns	
Fall time	$t_f$		6.3		ns	

## ■ Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	$Q_g$		39.6		nC	$I_D=25\text{ A}$ , $V_{DS}=50\text{ V}$ , $V_{GS}=10\text{ V}$
Gate-source charge	$Q_{gs}$		6.8		nC	
Gate-drain charge	$Q_{gd}$		8.0		nC	
Gate plateau voltage	$V_{plateau}$		3.5		V	

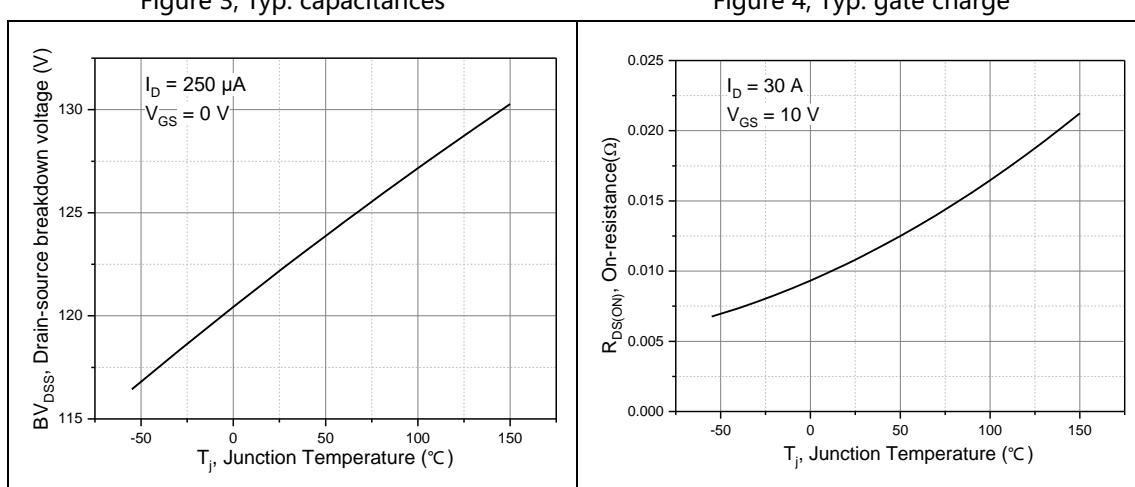
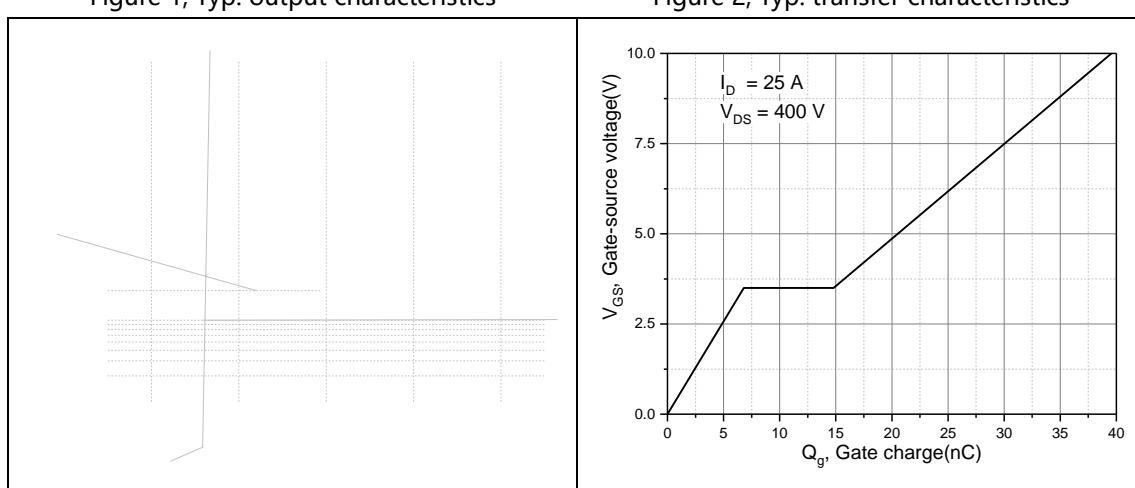
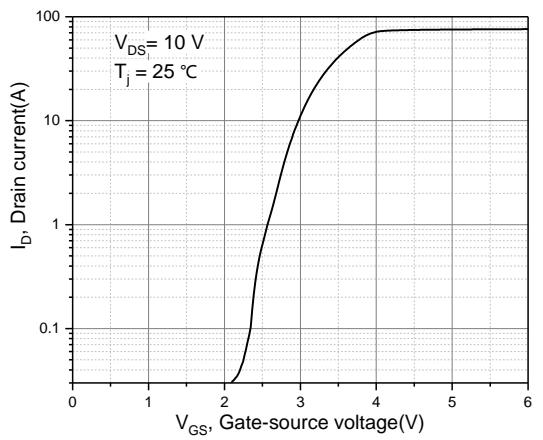
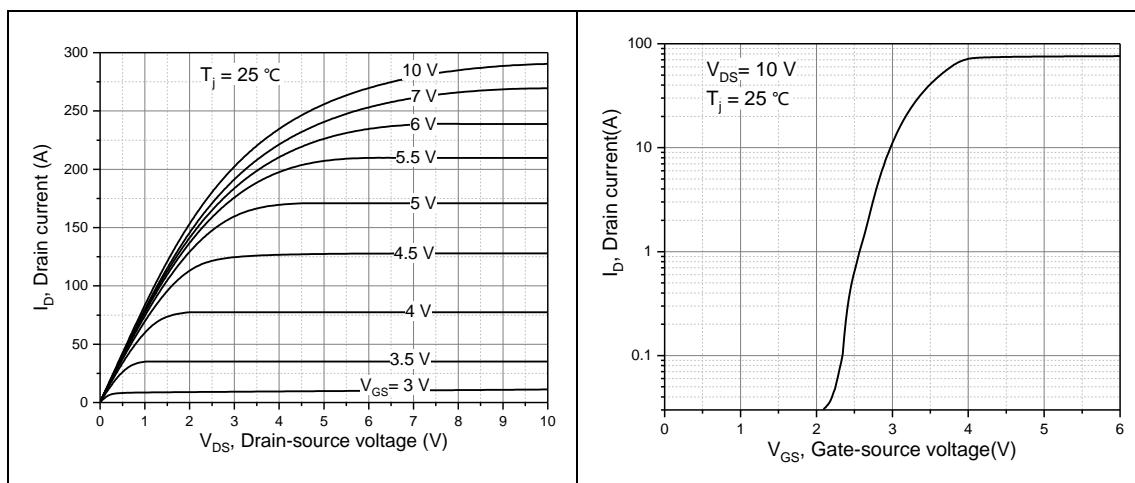
## ■ Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward current	$I_S$			60	A	$V_{GS} < V_{th}$
Pulsed source current	$I_{SP}$			180		
Diode forward voltage	$V_{SD}$			1.3	V	$I_S=60\text{ A}, V_{GS}=0\text{ V}$
Reverse recovery time	$t_{rr}$		79.5		ns	$I_S=25\text{ A}$ , $dI/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	$Q_{rr}$		210		nC	
Peak reverse recovery current	$I_{rrm}$		4.4		A	

## ■ Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ }^{\circ}\text{C}$ .
- 5)  $V_{DD}=50\text{ V}$ ,  $R_G=50\text{ }\Omega$ ,  $L=0.3\text{ mH}$ , starting  $T_j=25\text{ }^{\circ}\text{C}$ .

## ■ Electrical Characteristics Diagrams



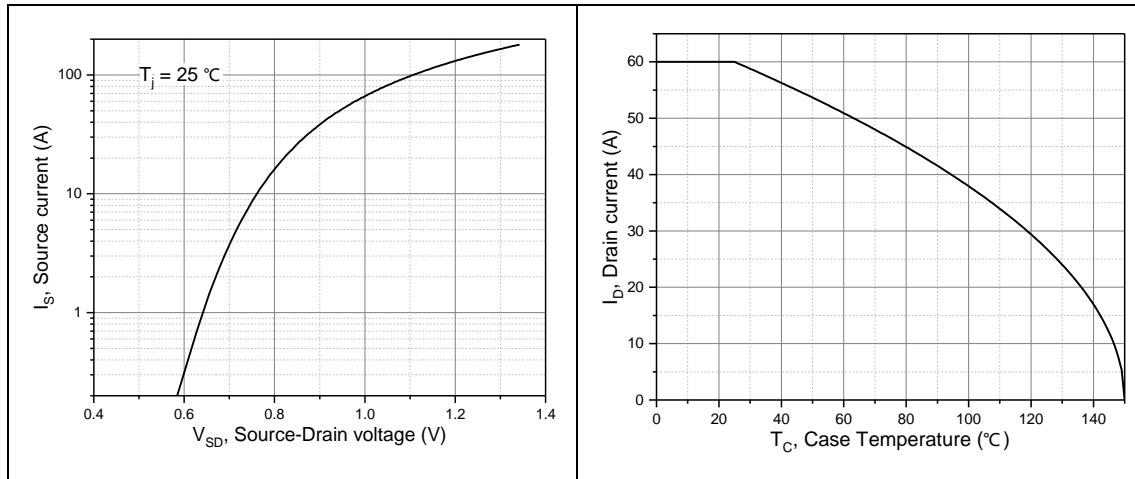
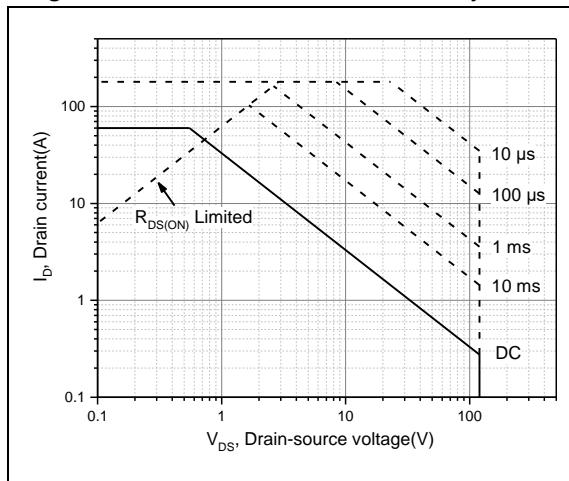


Figure 7, Forward characteristic of body diode

Figure 8, Drain current


 Figure 9, Safe operation area  $T_C=25\text{ }^{\circ}\text{C}$

## ■ Test circuits and waveforms

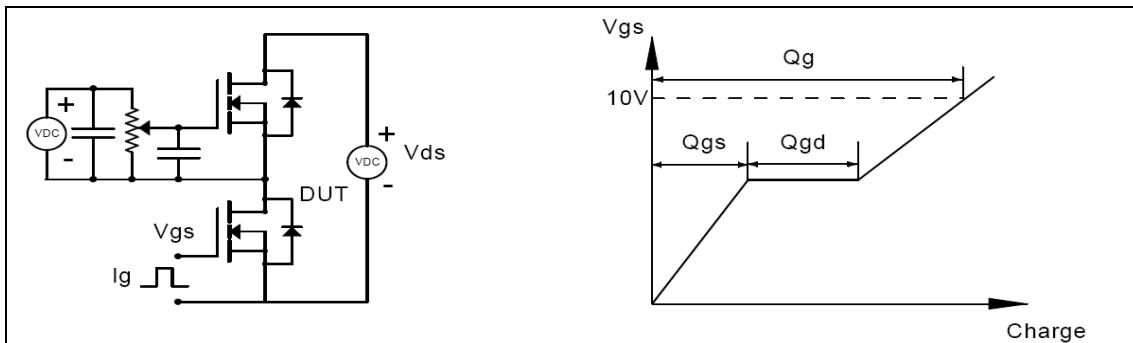


Figure 1, Gate charge test circuit & waveform

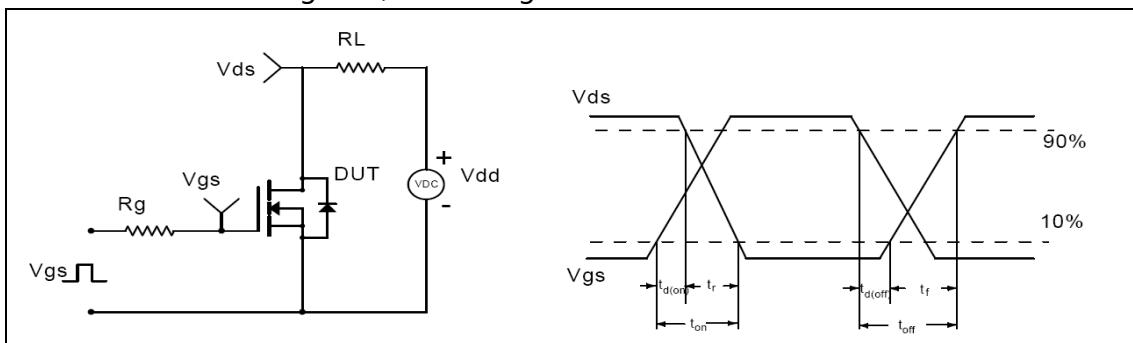


Figure 2, Switching time test circuit & waveforms

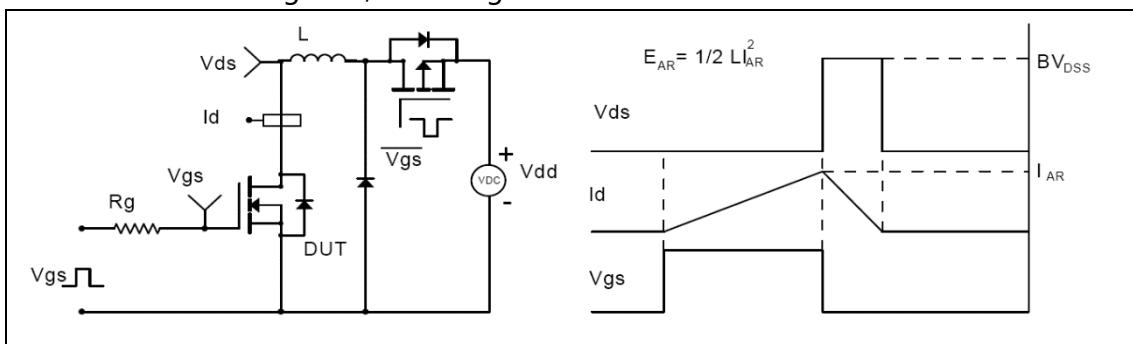


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

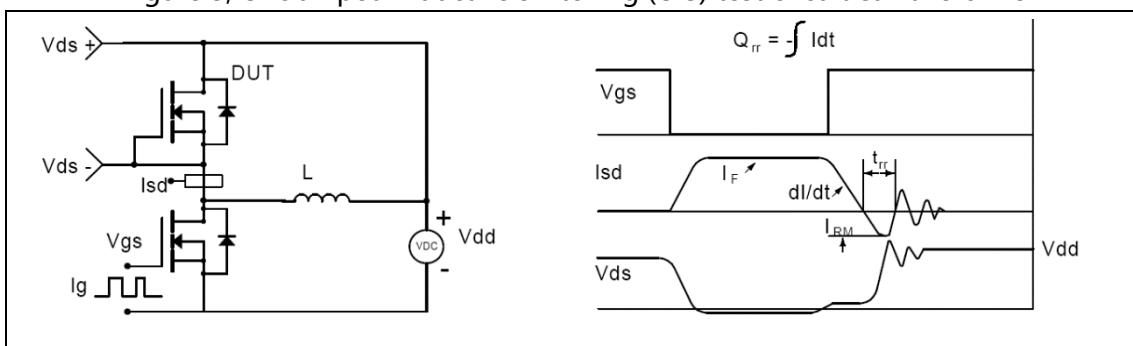
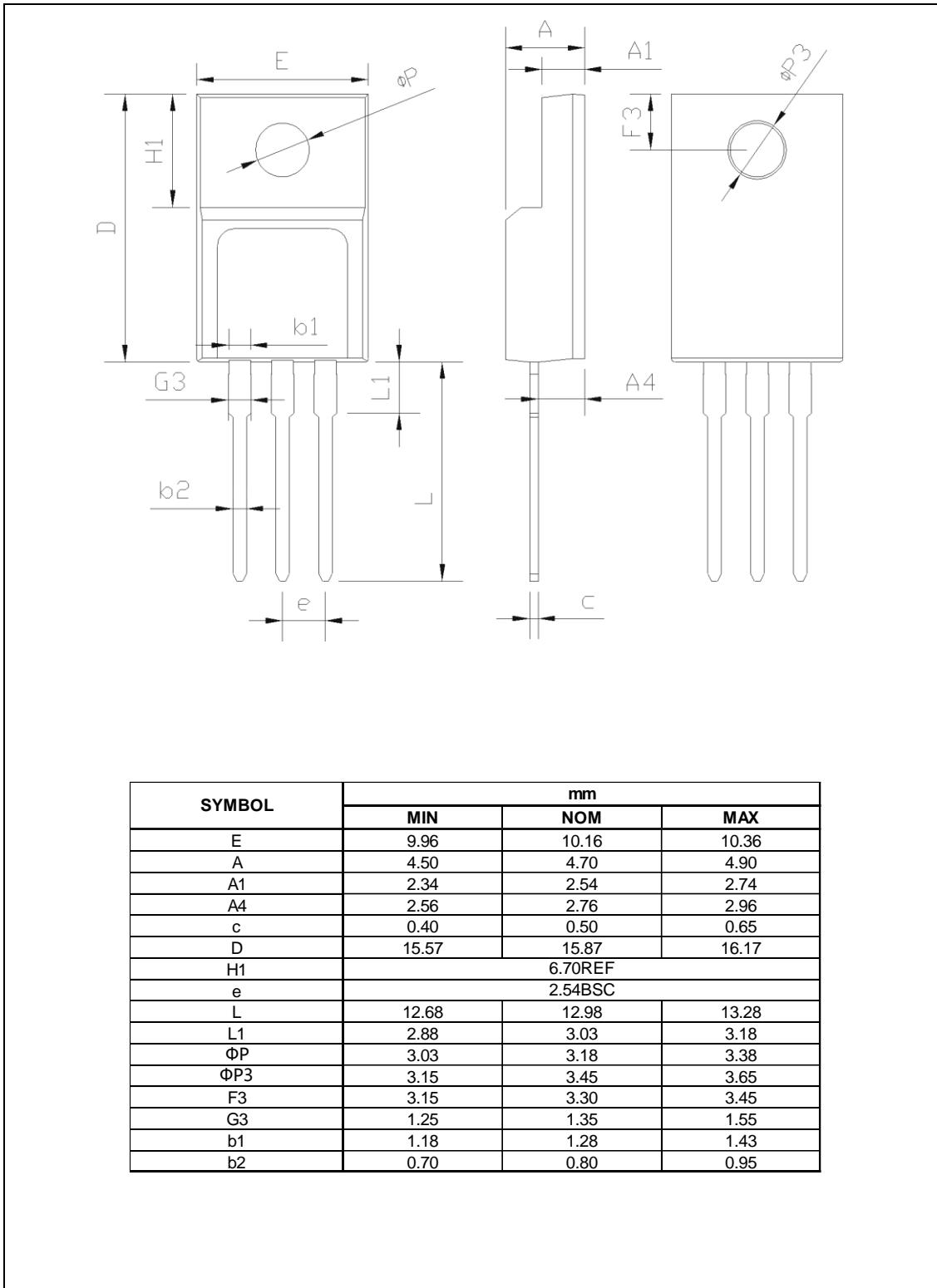


Figure 4, Diode reverse recovery test circuit & waveforms

## ■ Package Information

Figure1, TO220F package outline dimension



## ■ Ordering Information

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Package	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO220F	50	20	1000	6	6000

## ■ Product Information

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Product	Package	Pb Free	RoHS	Halogen Free
SFG60N12FF	TO220F	yes	yes	yes